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MOSFET - Power, Single N-Channel, SO-8 FL

30 V, 3.4 mΩ, 71 A NVMFS4C306N

Features

- Low RDS(on) to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- AEC-Q101 Qualified and PPAP Capable
- NVMFS4C306NWF Wettable Flanks Option for Enhanced Optical Inspection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Reverse Battery Protection
- DC-DC Converters Output Driver

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

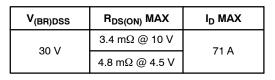
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage		V _{DSS}	30	V	
Gate-to-Source Volta	Gate-to-Source Voltage		V _{GS}	±20	V
Continuous Drain		$T_A = 25^{\circ}C$	۱ _D	20.6	А
Current R _{θJA} (Notes 1, 2)		T _A = 100°C		14.5	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)		T _A = 25°C	PD	3	W
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 2, 3)	Steady State	T _C = 25°C	Ι _D	71	A
Continuous Drain Current R _{θJC} (Notes 1, 2, 3)		$T_C = 100^{\circ}C$		50	
Power Dissipation $R_{\theta JC}$ (Notes 1, 2, 3)		T _C = 25°C	PD	36.5	W
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	166	А
Operating Junction and Storage Temperature Range			T _J , T _{STG}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	28	А
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{GS} = 10 V, I _L = 37 A _{pk} , L = 0.1 mH, R _{GS} = 25 Ω) (Note 3)		E _{AS}	68	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

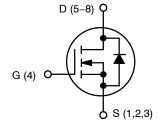
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.

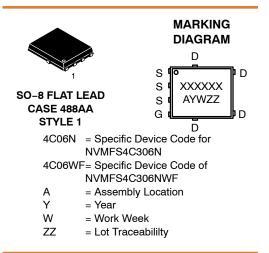
2. Surface-mounted on FR4 board using the minimum recommended pad size.

3. Parts are 100% tested at T_J = 25°C, \bar{V}_{GS} = 10 V, I_L = 27 Apk, E_{AS} = 36 mJ.









ORDERING INFORMATION

Device	Package	Shipping [†]
NVMFS4C306NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel

DISCONTINUED (Note 1)

NVMFS4C306NWFT1G	SO-8 FL	1500 /
	(Pb-Free)	Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

 DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on <u>www.onsemi.com</u>.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter		Value	Unit
Junction-to-Case (Drain)	$R_{ ext{ heta}JC}$	4.1	°C/W
Junction-to-Ambient – Steady State	$R_{ hetaJA}$	49	C/VV

ELECTRICAL CHARACTERISTICS (T = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	V_{GS} = 0 V, $I_{D(aval)}$ = 12.6 A, T _{case} = 25°C, t _{transient} = 100 ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				14.4		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25°C T _J = 125°C			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 4)				1		1	
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250 μA		1.3		2.1	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.8		mV/°0
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		2.8	3.4	_
		V _{GS} = 4.5 V	I _D = 30 A		4.0	4.8	mΩ
Forward Transconductance	9fs	V _{DS} = 1.5 V, I _D = 15 A			58		S
Gate Resistance	R _G	T _A = 25°C		0.3	1.0	2.0	Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				1683		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 15 V			841		pF
Reverse Transfer Capacitance	C _{RSS}				40		
Capacitance Ratio	C _{RSS} /C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz			0.023		
Total Gate Charge	Q _{G(TOT)}				11.6		
Threshold Gate Charge	Q _{G(TH)}				2.6]
Gate-to-Source Charge	Q _{GS}	V_{GS} = 4.5 V, V_{DS} = 15 V; I_{D} = 30 A			4.7		nC
Gate-to-Drain Charge	Q _{GD}				4.0		
Gate Plateau Voltage	V _{GP}				3.1		V
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A			26		nC
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			10		ns
Rise Time	t _r				32		
Turn-Off Delay Time	t _{d(OFF)}				18		
				h	1		

Fall Time 5.0 t_f Turn-On Delay Time 8.0 t_{d(ON)} **Rise Time** t_r 28 $\begin{array}{l} V_{GS} = 10 \text{ V}, V_{DS} = 15 \text{ V}, \\ I_D = 15 \text{ A}, \text{ } R_G = 3.0 \text{ } \Omega \end{array}$ ns Turn-Off Delay Time 24 $t_{d(OFF)}$ Fall Time t_f 3.0

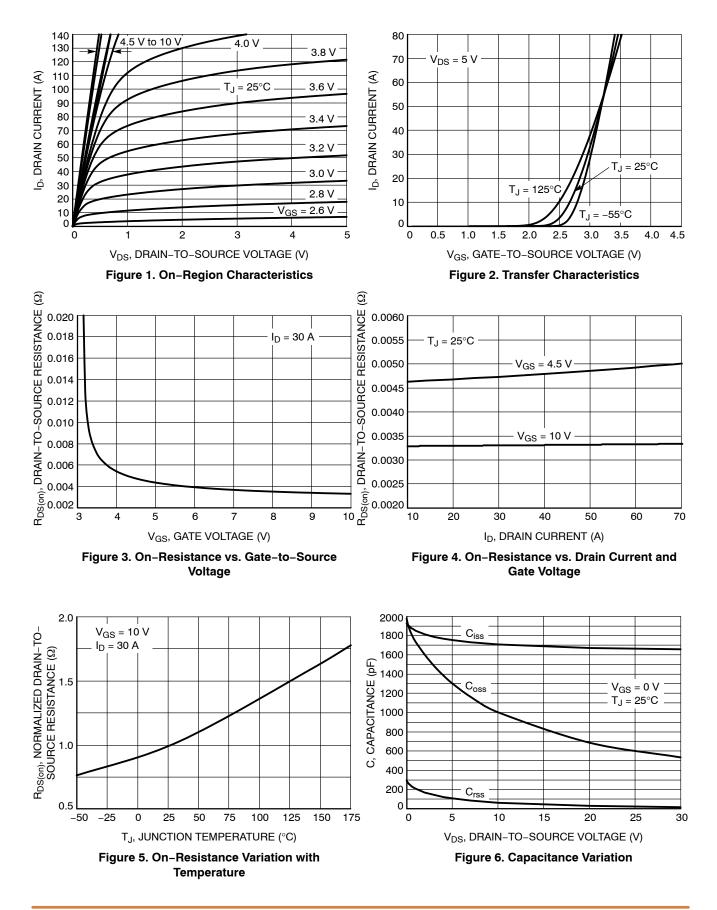
 $\begin{array}{ll} \mbox{4. Pulse Test: pulse width } \le 300 \ \mu \mbox{s, duty cycle } \le 2\%. \\ \mbox{5. Switching characteristics are independent of operating junction temperatures.} \end{array}$

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

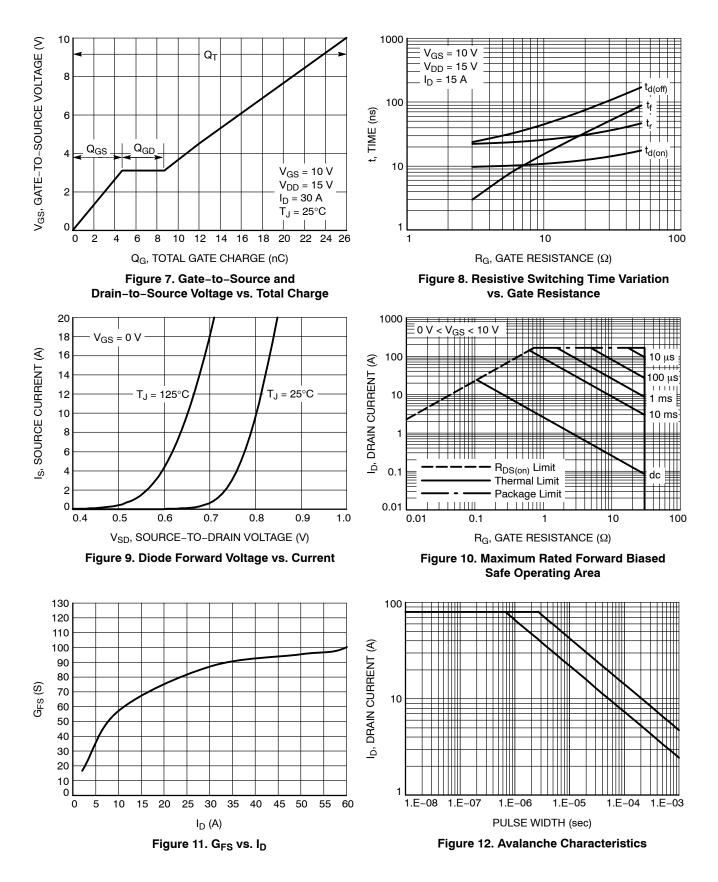
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS								
Forward Diode Voltage	V_{SD}	$v_{GS} = 0 v,$	$T_J = 25^{\circ}C$		0.8	1.1	v	
			T _J = 125°C		0.63			
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dlS/dt = 100 A/µs, I _S = 30 A			34			
Charge Time	t _a				17		ns	
Discharge Time	t _b				17			
Reverse Recovery Charge	Q _{RR}				22		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



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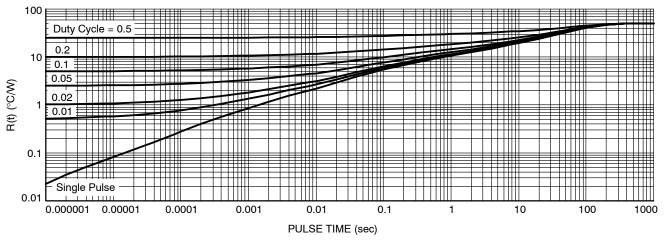


Figure 13. Thermal Response

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